Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1341	(427/162).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:29
L2	1811	(427/163.1,164,165).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:31
L3	1300	(427/264,270,271).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:31
L4	537	(427/277,278).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:48
L5	676	(427/355).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:58
L6	2182	(427/372.2).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:28
L7	433	(427/374.1).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 11:10
L8	696	(427/375).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 11:18
L9	2845	(427/385.5).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:28
L10	653	(427/389.7).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 11:29
L11	368	(264/1.31,1.34).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 11:29
L12	1443	(264/1.1,1.7,1.9).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 11:34
L13	1378	(349/67,113).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/13 10:29
L14	13757	1 2 3 4 5 6 7 8 9 10 11 12 13	US-PGPUB; USPAT	OR	ON	2005/10/13 10:29
L15	0	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4)) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((heat$5 or bake or baked or baking or sinter$5 or anneal$5 or oven) with (coat$4 or film or layer) with (align$5 or polyimide or orient$8)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:55

L16	1	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4)) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((coat$4 or film or layer) with (align$5 or polyimide or orient$8)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:43
L17	1	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4))).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((coat$4 or film or layer) with (align$5 or polyimide or orient$8)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:43
L18	2	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4))).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((align$5 or polyimide or orient$8)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:43
L19	11	((cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4)) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:46
L20	10	L19 not L18	US-PGPUB; USPAT	OR	ON	2005/10/13 11:46

L21	0	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4) or soften$4) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((heat$5 or bake or baked or baking or sinter$5 or anneal$5 or oven) with (coat$4 or film or layer) with (align$5 or polyimide or orient$8)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:49
L22	1	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4) or soften$4) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((coat$4 or film or layer) with (align$5 or polyimide or orient$8)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:49
L23	2	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4) or soften$4) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity) or pattern$5 or ridge or stripe or groove or $5structure)).clm. and ((heat$5 or bake or baked or baking or sinter$5 or anneal$5 or oven) with (coat$4 or film or layer) with (below or beneath or under or underneath or low$5 or less) with (Tg or soften$5 or "T.sub.g" or (glass adj transition$5))).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:53

L24	5	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4) or soften$4) with (greater or high$5 or above or rais$5 or increas$5)). clm. and ((stamp$4 or die or emboss$6)).clm. and ((heat$5 or bake or baked or baking or sinter$5 or anneal$5 or oven) with (coat$4 or film or layer) with (below or beneath or under or underneath or low$5 or less) with (Tg or soften$5 or "T.sub.g" or (glass adj transition$5))).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:54
L25	3	L24 not L23	US-PGPUB; USPAT	OR	ON	2005/10/13 11:54
L26	1	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4)) with (greater or high$5 or above or rais$5 or increas$5)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity))).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:55
L27	1	((coat$5 or deposit$5 or film or layer) with (cure or cured or curing or harden$5 or polymeriz$8) with (Tg or "T.sub.g" or (glass adj transition$4) or soften$4)).clm. and ((stamp$4 or die or emboss$6 or press$4) with (microasperity or (micro adj asperity))).clm.	US-PGPUB; USPAT	OR	ON	2005/10/13 11:56

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	US-PGPUB; USPAT	OR	ON	2005/10/13 12:08
L2	4	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:08
L3	6	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (glass near2 transition) and (decomposition)	US-PGPUB; USPAT	OR	ON	2005/10/13 12:09
L4	1	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature same (polymeriz$5 or cure or curing or cured or harden$4) same (glass near3 transition) same (decomposition))	US-PGPUB; USPAT	OR	ON	2005/10/13 12:09
L5	0	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz$5 or cure or curing or cured or harden$4) and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:09
L6	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:10
L7	55	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz$5 or cure or curing or cured) and (glass near3 transition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:10
L8	6	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (reflect$4 near3 (LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/10/13 12:10

L9	26	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect$4 near3 (LCD or (liquid adj crystal$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp$2 or roll$3 or die))	US-PGPUB; USPAT	OR	ON	2005/10/13 12:11
L11	3	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect$4 near3 (LCD or (liquid adj crystal$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp$2 or roll$3 or die))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:12
L12	94	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((pattern or groove or plate or asperity or microasperity or stamp$2 or roll$3 or die or press or pressing or pressed) same (Tg or "T.sub.g" or (glass near2 transition)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:14
L13	44	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$5 or harden) with (Tg or "T.sub.g" or (glass near2 transition)) with (above or higher or high or greater or increas$5 or rais$5 or hotter))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:19
L14	7	L13 and ((stamp$4 or press$4 or die or emboss$5) with (pattern$4 or $5pattern or microasperity or (micro adj asperity) or groove or ridge or $5structure))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:18
L15	37	L13 not L14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:18

L16	32	((coat$5 or deposit$5 or film or layer or resin$5) with (cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$6 or harden$4) with (Tg or "T.sub.g" or (glass near2 transition)) with (above or higher or high or greater or increas$5 or rais$5 or hotter)) and ((stamp$4 or press$4 or die or emboss$5) with (pattern$4 or $5pattern or microasperity or (micro adj asperity) or groove or ridge or $5structure)) and ((heat$5 or oven or bake or baked or baking or anneal$5 or sinter$4) with ((align$6 or orient$7 or polyimide) near3 (coat$4 or film or layer)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:30
L17	32	((coat$5 or deposit$5 or film or layer or resin$5) with (cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$6 or harden$4) with (Tg or "T.sub.g" or (glass near2 transition)) with (above or higher or high or greater or increas$5 or rais$5 or hotter or exceed$4)) and ((stamp$4 or press$4 or die or emboss$5) with (pattern$4 or $5pattern or microasperity or (micro adj asperity) or groove or ridge or $5structure)) and ((heat$5 or oven or bake or baked or baking or anneal$5 or sinter$4) with ((align$6 or orient$7 or polyimide) near3 (coat$4 or film or layer)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:51
L18	0	L17 not L16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:31

L19	93	((coat$5 or deposit$5 or film or layer or resin$5) with (cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$6 or harden$4) with (Tg or "T.sub.g" or (glass near2 transition)) near3 (above or higher or high or greater or increas$5 or rais$5 or hotter or exceed$4)) and ((stamp$4 or press$4 or die or emboss$5) with (pattern$4 or $5pattern or microasperity or (micro adj asperity) or groove or ridge or $5structure)) and (((align$6 or orient$7 or polyimide) near3 (coat$4 or film or layer)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/10/13 12:39
L20	68	L19 not L17	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:34
L21	27	((coat$5 or deposit$5 or film or layer or resin$5) with (cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$6 or harden$4) with (Tg or "T.sub.g" or (glass near2 transition)) near3 (above or higher or high or greater or increas$5 or rais$5 or hotter or exceed$4)) same ((stamp$4 or press$4 or die or emboss$5) with (pattern$4 or $5pattern or microasperity or (micro adj asperity) or groove or ridge or $5structure))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:47
L22	1	((coat$5 or deposit$5 or film or layer or resin$5) with (cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$6 or harden$4) with (Tg or "T.sub.g" or (glass near2 transition)) near3 (above or higher or high or greater or increas$5 or rais$5 or hotter or exceed$4)) and ((microasperity or (micro adj asperity)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:47

L23	28	((coat$5 or deposit$5 or film or layer or resin$5) with (cure or cured or curing or crosslink$5 or (cross adj link$5) or polymeriz$6 or harden$4) with (Tg or "T.sub.g" or (glass near2 transition)) with (above or higher or high or greater or increas$5 or rais$5 or hotter or exceed$4)) and ((heat$5 or oven or bake or baked or baking or anneal$5 or sinter$4) with ((align$6 or orient$7 or polyimide) near3 (coat$4 or film or layer)) with (below or low$5 or beneath or under or underneath or colder or cooler or less) near4 (Tg or "T.sub.g" or (glass near2 transition) or soften$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 12:53
L24	13005	((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:38
L25	2	(((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)) and (microasperity or (micro adj asperity))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:38
L26	0	((427/271).CCLS.) and ((349/67, 113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L27	0	((427/277,278).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L28	0	((427/372.2,374.1,375,384,385.5, 389.7).CCLS.) and ((349/67,113). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L29	0	((264/1.31,1.1,1.34,1.9).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L30	2	((427/162,163.1,164,165).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L31	34	((427/162,163.1,164,165).CCLS.) and ((427/271).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L32	19	((427/162,163.1,164,165).CCLS.) and ((427/277,278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:39
L33	65	((427/162,163.1,164,165).CCLS.) and ((264/1.31,1.1,1.34,1.9). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:40

L34	0	((427/277,278).CCLS.) and (reflect$5 with (LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:40
L35	5	((427/277,278).CCLS.) and ((LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:40
L36	6	(microasperity or (micro adj asperity)) and (reflect$5 with (LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:40
L37	51	((349/67,113).CCLS.) and (pattern$3 with (stamp$3 or master or emboss$4 or roll$3))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:40
L39	86	((reflect$5 with (LCD or (liquid adj crystal$4 adj display))) and ((pattern$3 or resin$4 or polyimide or polymer$2) with (stamp$3 or master or emboss$4 or roll$3)) and (((427/162,163.1, 164,165).CCLS.) ((427/271).CCLS.) ((427/277,278).CCLS.) ((427/372.2,374.1,375,384,385.5, 389.7).CCLS.) ((264/1.31,1.1,1. 34,1.9).CCLS.) ((349/67,113). CCLS.))) not (((349/67,113).CCLS.) and (pattern$3 with (stamp$3 or master or emboss$4 or roll$3)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:42
L40	18	((427/277,278).CCLS.) and ((glass adj transition) or Tg or "T.sub.g" or "T.sub.G")	US-PGPUB; USPAT	OR	ON	2005/10/13 13:44
L41	0	((((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing) near3 temperature))) and ((427/277, 278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:44
L42	81	((((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing) near3 temperature))) and (((427/162, 163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.).)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:45

L44	47	((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing or reaction) near3 temperature)) and ((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near6 (glass adj transition)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:45
L45	38	((coat$3 or deposit$3 or spincoat$3) with (temperature) with (lower or below or under) near4 ((polymeriz$5 or curing or reaction) near3 temperature with (begin$5 or initiat$8 or start$5 or commenc$5)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:47
L47	52	((coat$3 or deposit$3 or spincoat$3) with (temperature) with (lower or below or under) near4 ((polymeriz$5 or curing or reaction) near3 temperature with (begin$5 or initiat$8 or start$5 or commenc$5)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 13:48
L49	1	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((427/277,278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:49
L50	5	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:49

L51	58	(((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))) not (((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:50
L52	3	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 13:51
L53	209	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master or emboss$5))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:52

L54	86	(((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press or pressing or pressed or stamp$3 or roll$3 or die or master or emboss$5))) not ((((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))) not (((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:53
L56	7	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (coat$3 or deposit$4 or film or layer or apply$3 or application) with (benefi$8 or advantag$7 or prefer$6 or optim$6))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:53
L57	80	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi$8 or advantag$7 or prefer$6 or optim$6))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:53
L58	32	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi$8 or advantag$7 or prefer$6 or optim$6))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 13:54
L60	41	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften$4)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:54

L61	13	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften$4)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 13:54
L62	36	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 13:55
L64	43	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2)))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:55
L65	30	((cure or cured or curing or harden$3 or polymeriz$5)) same ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2))) same ((stamp$5 or emboss$5 or roll$4 or die or press or pressed or pressing) near6 (pattern$4 or convex or concave or indent$6))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:55
L66	80	(((cure or cured or curing or harden$3 or polymeriz$5)) same ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2))) same ((stamp$5 or emboss$5 or roll$4 or die or press or pressed or pressing))) and (((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/10/13 13:56
L67	88	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (Tg or "T.sub.g")	US-PGPUB; USPAT	OR	ON	2005/10/13 13:56

L69	98	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/10/13 13:58
L70	6	(stress$3) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/10/13 14:00
L71	1	(relax$7) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/10/13 14:01
L72	20	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near4 (soften$4) with (Tg or "T.sub.g" or (glass near2 transition))	US-PGPUB; USPAT	OR	ON	2005/10/13 14:01
L73	0	(stress$3 or relax$7) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:01
L74	33	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:01
L75	375	(((cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))) not ((coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))	US-PGPUB; USPAT	OR	ON	2005/10/13 14:01
L77	61	((cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp$5 or pattern$4 or press$3 or die or emboss$5)	US-PGPUB; USPAT	OR	ON	2005/10/13 14:04

L78	13	((cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp$5 or pattern$4 or press$3 or die or emboss$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:04
L79	14	(spincoat$3 or (spin adj coat$3)) with (resin$5 or monomer$3 or prepolymer$4 or solution or liquid) with (temperature) with (lower or below or under) near4 (cure or cured or curing or polymeriz$6 or harden$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:05
L80	16	(spincoat$3 or (spin adj coat$3)) with (temperature) near3 (lower or below or under) near4 (cure or cured or curing or polymeriz$6 or harden$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:05
L82	16	(spincoat$3 or (spin adj coat$3)) with (temperature) near3 (lower or below or under) near4 (cure or cured or curing or polymeriz$6 or harden$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:05
L83	16	((coat$4 or spincoat$4 or deposit$5 or film or layer or apply$4 or application) with (polymer$2 or resin$4 or plastic or oligomer$4 or monomer$4 or prepolymer$4) with (temperature) with (below or lower or under or beneath or less) with (cure or cured or curing or harden$4 or polymeriz$6 or reaction) with (start$4 or initiat$7 or begin$5 or commenc$6)) and ((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (temperature) with (above or greater or higher or over or increas$5) with (Tg or "T.sub.g" or (glass adj transition))) and (microasperity or pattern$4 or emboss$4 or stamp$4 or master or die or mold$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:06
L84	13005	((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/10/13 14:07

L85	1263	((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (temperature) with (above or greater or higher or over or increas$5) near3 (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or pattern$4 or emboss$4 or stamp$4 or master or die or mold$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:07
L86	42	L85 and L84	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:08
L87	105	((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (coat$5 or film or layer or deposit$5) with (temperature) with (above or greater or higher or over or increas$5) with (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or emboss$4 or stamp$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:09
L88	11	((microasperity or emboss$4 or stamp$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) with (cure or cured or curing or polymeriz$8 or harden$5)) same (Tg or "T.sub.g" or (glass adj transition))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:12
L89	278	((microasperity or emboss$4 or stamp$4) near3 (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) near2 (cure or cured or curing or polymeriz$8 or harden$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:12

L90	26	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5 or soften$5 or melt$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:15
L92	74	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5 or soften$5 or melt$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:16
L93	95	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5 or soften$5 or melt$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4 or imprint$5 or print$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:18
L94	278	((microasperity or emboss$4 or stamp$4) near3 (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) near2 (cure or cured or curing or polymeriz$8 or harden$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:18
L95	15	L94 and L84	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:18

L96	15	L94 and L84	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:18
L97	263	L94 not L96	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:18
L99	14	((microasperity or emboss$4 or stamp$4) near3 (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) near2 (cure or cured or curing or polymeriz$8 or harden$5)) same (Tg or soften$5 or melt$5 or "T.sub.g" or (glass near2 transition))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:20
L102	1258	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4 or imprint$5 or print$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:20
L103	43	L102 and L84	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:21
L105	35	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or (pressed or press or pressing or mold$4 or die) near5 (microasperity or (micro adj asperity) or pattern$4 or imprint$5)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:22

L106	43	L102 and L84	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/13 14:23
L107	110	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or (pressed or press or pressing or mold$4 or die) near5 (microasperity or (micro adj asperity) or pattern$4 or imprint$5)))	US-PGPUB; USPAT	OR	ON	2005/10/13 14:23
L108	101	L107 not L106	US-PGPUB; USPAT	OR	ON	2005/10/13 14:23